



## Description

The 5N10-HXY uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

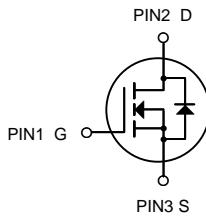


## General Features

$V_{DS} = 100V$   $I_D = 5A$

$R_{DS(ON)} < 120m\Omega$  @  $V_{GS}=10V$

$R_{DS(ON)} < 143m\Omega$  @  $V_{GS}=4.5V$



N-Channel MOSFET

## Application

Battery protection

Load switch

Uninterruptible power supply

## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
5N10-HXY	SOT-23-3L	1005	3000

## Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current-Continuous	5	A
$IDM$	Drain Current-Pulsed (Note 1)	20	A
$P_D$	Maximum Power Dissipation	1.5	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 175	°C
$R_{\theta JA}$	Thermal Resistance,Junction-to-Ambient (Note 2)	100	°C/W



**Electrical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	100	-	-	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b> (Note 3)						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.0	1.5	2.0	V
Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=3\text{A}$	-	100	120	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=3\text{A}$	-	130	143	
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}}=5\text{V}, I_{\text{D}}=3\text{A}$	-	5	-	S
<b>Dynamic Characteristics</b> (Note 4)						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	650	-	PF
Output Capacitance	$C_{\text{oss}}$		-	24	-	PF
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	20	-	PF
<b>Switching Characteristics</b> (Note 4)						
Turn-on Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}}=50\text{V}, R_{\text{L}}=19\Omega$ $V_{\text{GS}}=10\text{V}, R_{\text{G}}=3\Omega$	-	6	-	nS
Turn-on Rise Time	$t_{\text{r}}$		-	4	-	nS
Turn-Off Delay Time	$t_{\text{d(off)}}$		-	20	-	nS
Turn-Off Fall Time	$t_{\text{f}}$		-	4	-	nS
Total Gate Charge	$Q_{\text{g}}$	$V_{\text{DS}}=50\text{V}, I_{\text{D}}=3\text{A}, V_{\text{GS}}=10\text{V}$	-	20	-	nC
Gate-Source Charge	$Q_{\text{gs}}$		-	2.1	-	nC
Gate-Drain Charge	$Q_{\text{gd}}$		-	3.3	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 3)	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{s}}=3\text{A}$	-	-	1.2	V
Diode Forward Current (Note 2)	$I_{\text{s}}$		-	-	3	A

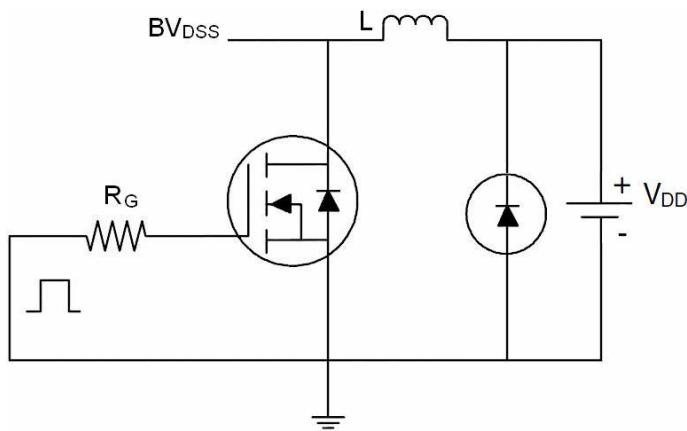
**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

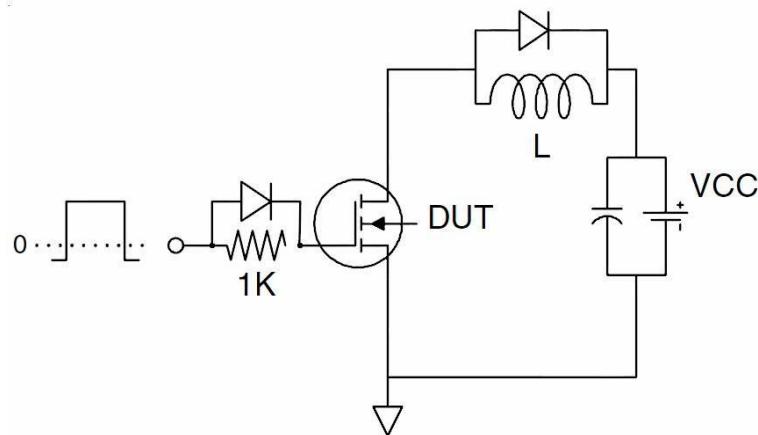


## Test Circuit

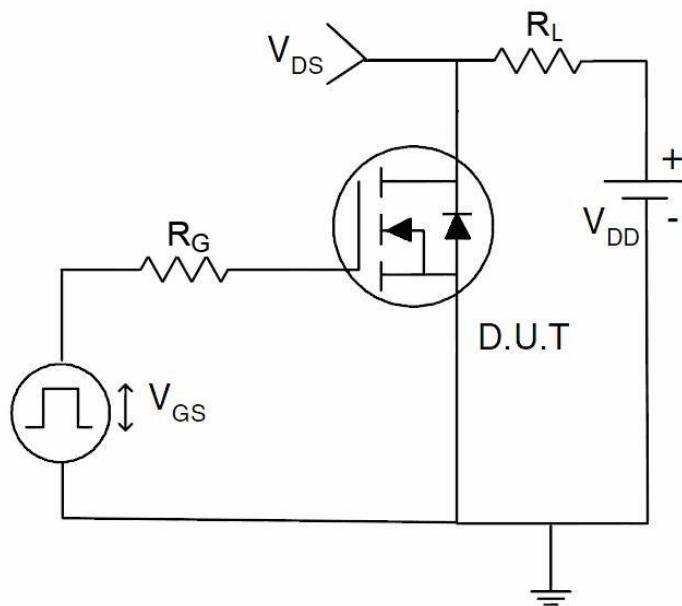
### 1) E<sub>AS</sub> test circuit



### 2) Gate charge test circuit



### 3) Switch Time Test Circuit





### Typical Electrical and Thermal Characteristics (Curves)

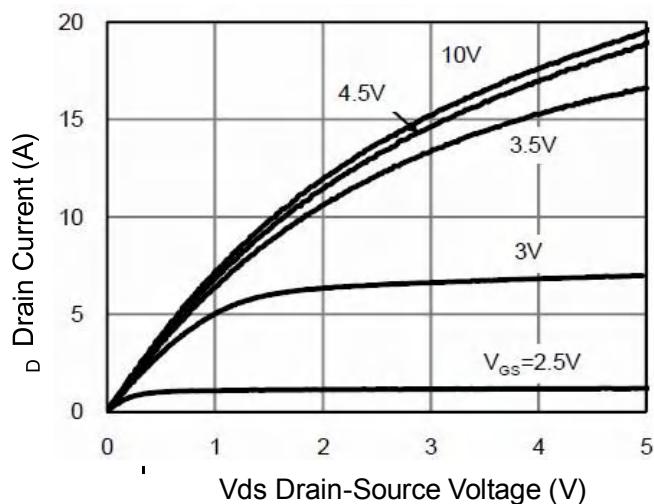


Figure 1 Output Characteristics

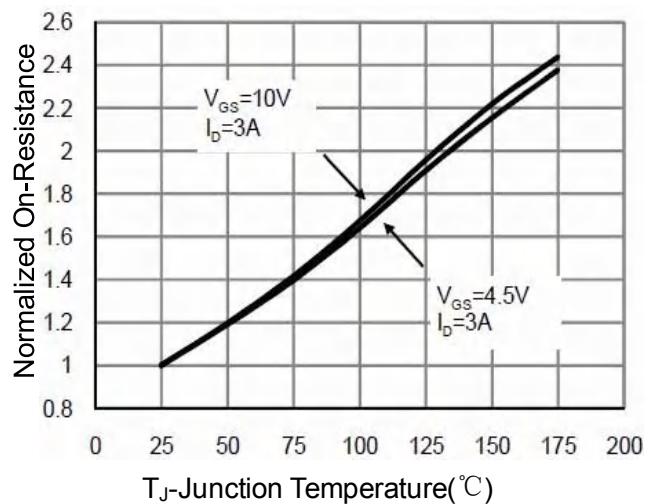
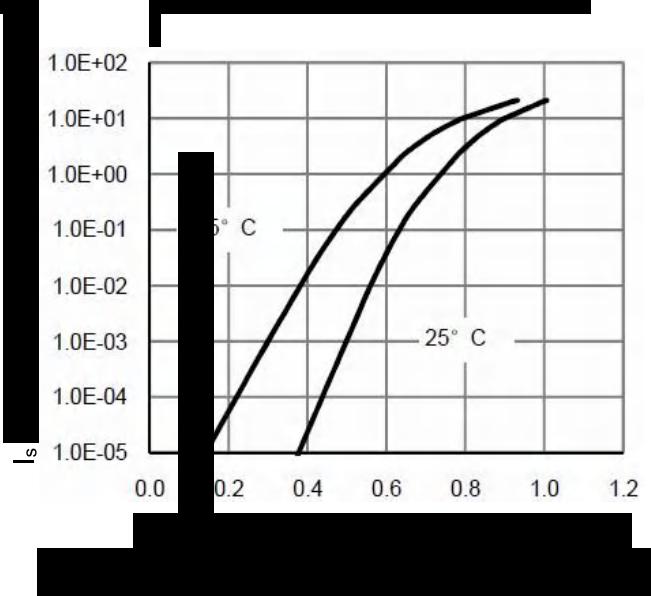
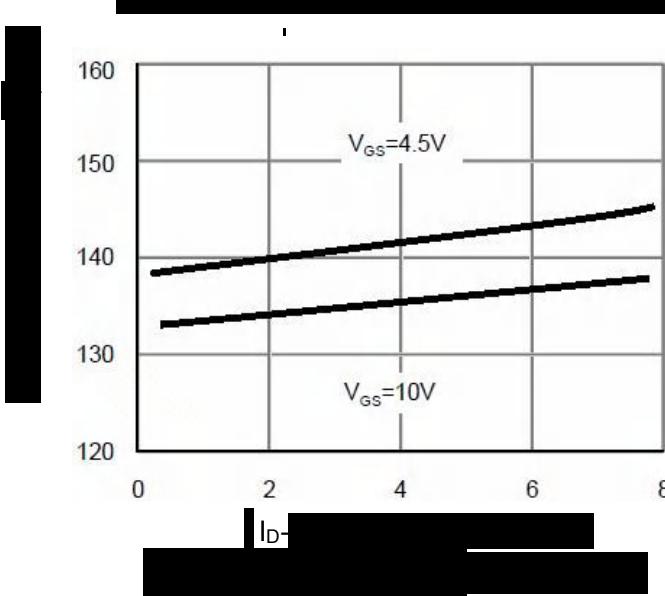
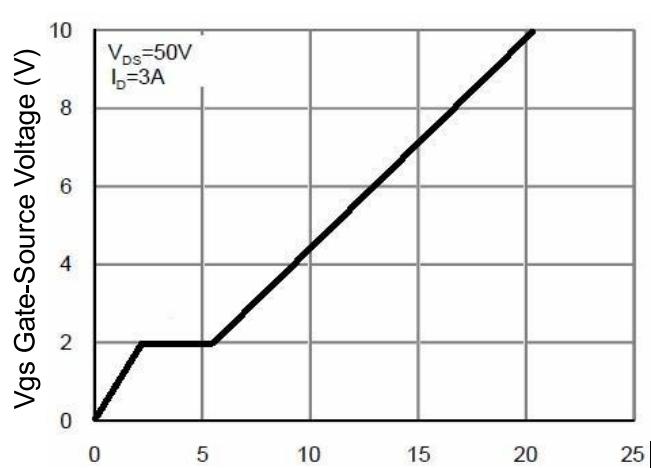
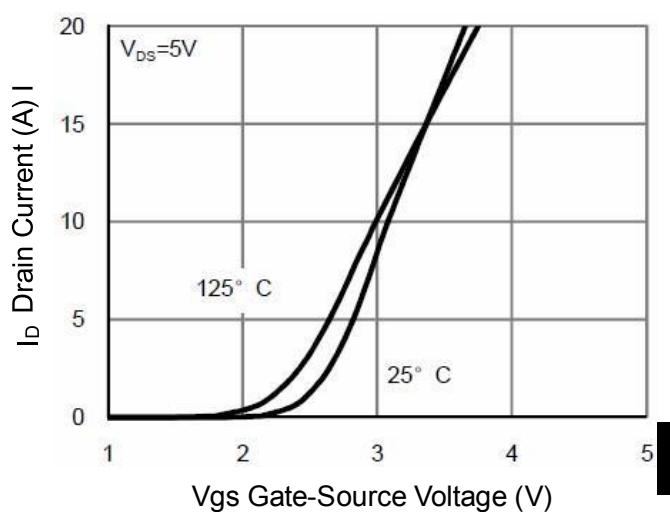


Figure 4 Rdson-JunctionTemperature



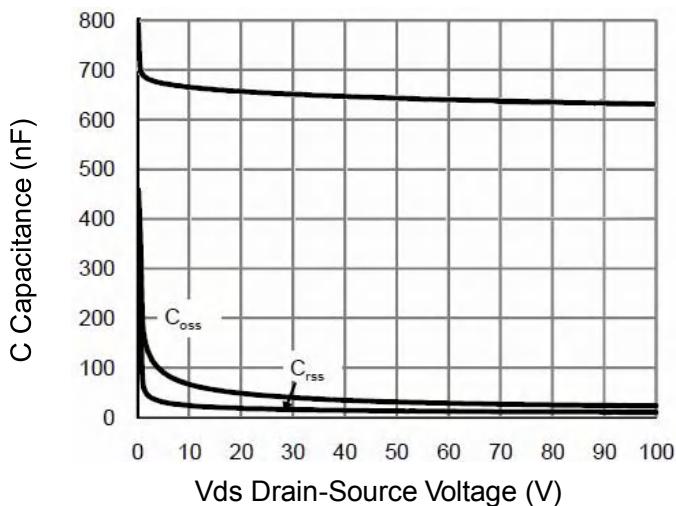


Figure 7 Capacitance vs Vds

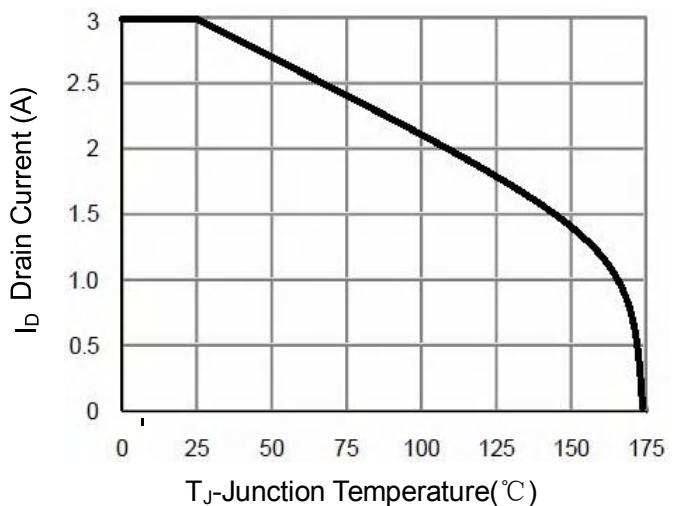


Figure 9  $BV_{DSS}$  vs Junction Temperature

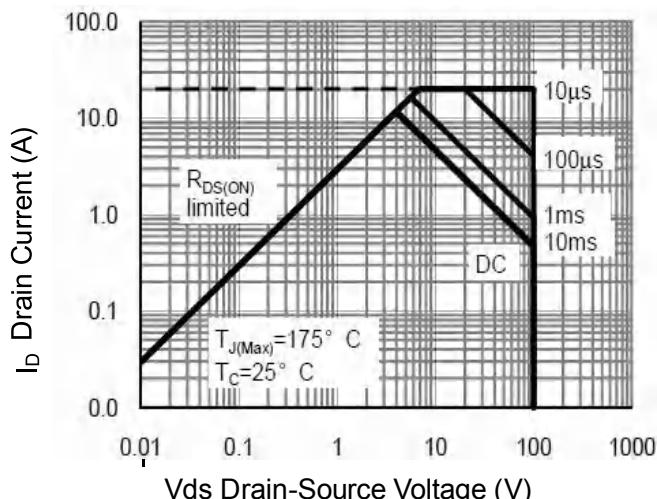


Figure 8 Safe Operation Area

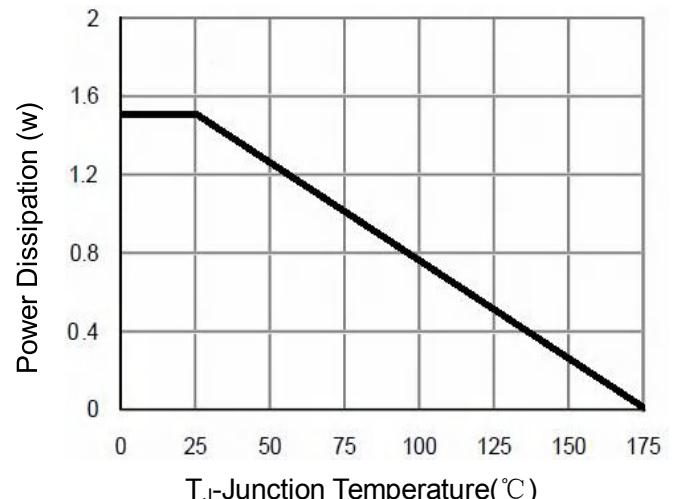


Figure 10 Power De-rating

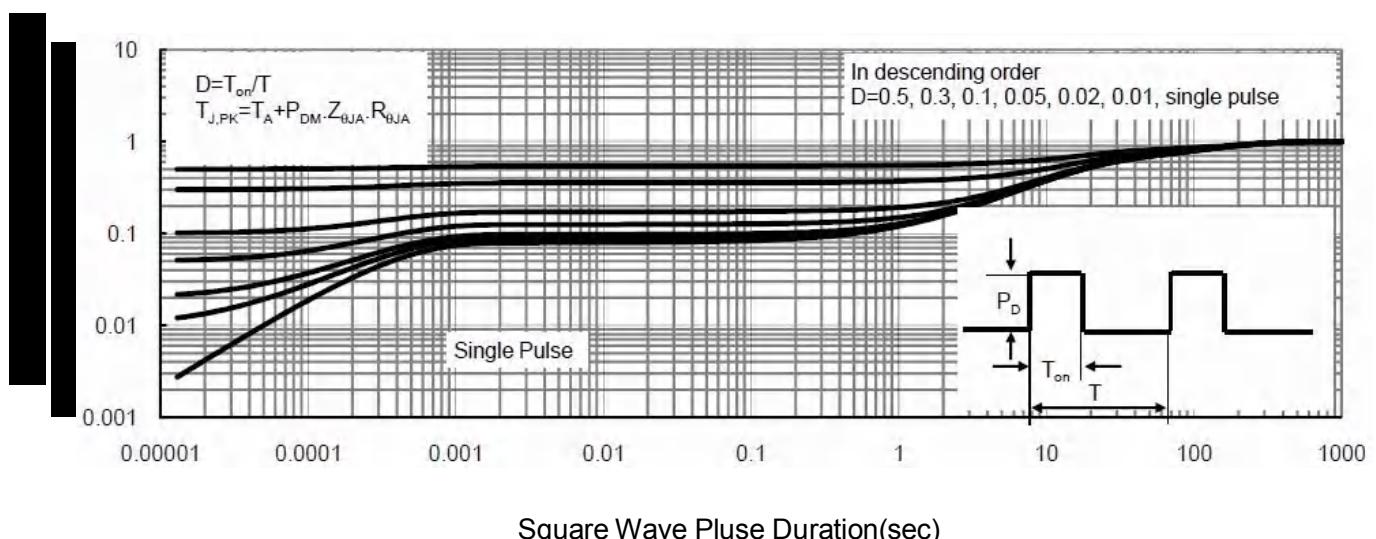
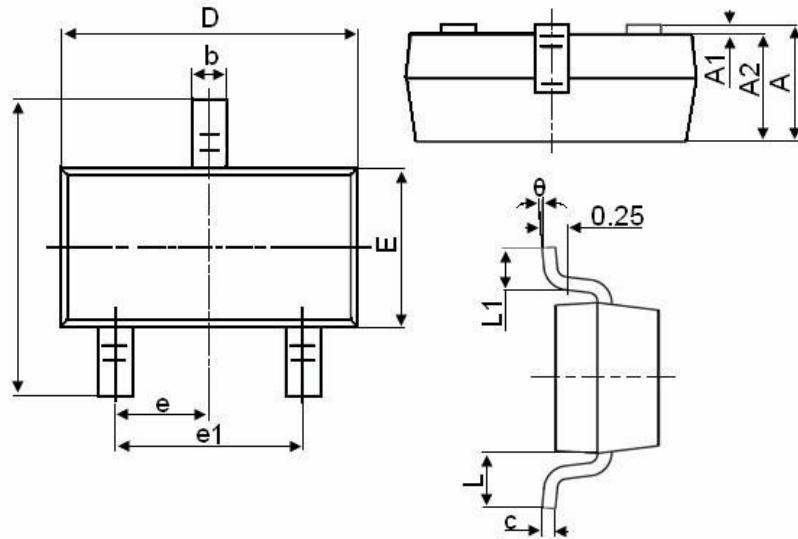


Figure 11 Normalized Maximum Transient Thermal Impedance



### SOT-23-3L Package Information



Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.300	0.500
c	0.100	0.200
D	2.800	3.000
E	1.500	1.700
E1	2.650	2.950
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.600
θ	0°	8°



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